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EDUCATION

Princeton University

Doctor of Philosophy (Ph.D.) in Mechanical and Aerospace Engineering
Master of Arts (M.A.) in Mechanical and Aerospace Engineering

Princeton, NJ
2012–2019

The Pennsylvania State University

Non-Degree Graduate Student in Acoustics (attended online)

University Park, PA
2012–2014

University of Maryland

Bachelor of Science (B.S.) in Physics with a minor in Philosophy, *cum laude*

College Park, MD
2008–2012

EXPERIENCE

Siemens Technology US

Senior Key Expert, Sustainable Automation Solutions
Research Scientist, Technology Field: Future of Automation

Princeton, NJ
2022–present
2019–2022

Princeton University

Doctoral Candidate, 3D Audio and Applied Acoustics Laboratory
Assistant in Instruction, Department of Mechanical and Aerospace Engineering

Princeton, NJ
2012–2019
2014–2017

University of Maryland

Undergraduate Research Assistant, Cosmic Ray Laboratory
Teaching Assistant, Department of Physics

College Park, MD
2009–2012
Fall 2011

SELECTED PROJECTS

Audio Connector for Siemens Industrial Edge

Role: *Lead Software Developer*

Siemens Digital Industries
2022–present

Autonomous Robotic Spraying & Disinfection System

Role: *Principal Investigator*

Advanced Robotics for Manufacturing (ARM) Institute
2020–2021

RECON: Resilient Control Systems for Naval Vessels

Role: *Research Scientist*

U.S. Naval Research Laboratory (NRL)
2019–2020

Virtual Navigation of 3D Sound Fields

Role: *Doctoral Candidate*

Sony Corporation of America
2015–2019

SELECTED PUBLICATIONS

¹ J. Tylka, A. Martinez Canedo, S. Srivastava, K. Goyal, and A. Breu. System and method to automatically generate and optimize recycling process plans for integration into a manufacturing design process, Aug. 31, 2021. WO Patent Application WO2022051236A1.

² E. Y. Choueiri and J. Tylka. System and Method for Virtual Navigation of Sound Fields through Interpolation of Signals from an Array of Microphone Assemblies, June 8, 2021. US Patent 11,032,663.

³ J. Luo, M. Kang, E. Bisse, M. Veldink, D. Okunev, S. Kolb, J. G. Tylka, and A. Canedo. A Quad-Redundant PLC Architecture for Cyber-Resilient Industrial Control Systems. *IEEE Embedded Systems Letters*, page 4, 2020.

⁴ J. G. Tylka and E. Y. Choueiri. Performance of Linear Extrapolation Methods for Virtual Sound Field Navigation. *The Journal of the Audio Engineering Society*, 68(3):138–156, March 2020.

⁵ R. Sridhar, J. G. Tylka, and E. Y. Choueiri. Generalized Metrics for Constant Directivity. *The Journal of the Audio Engineering Society*, 67(9):666–678, September 2019.

⁶ E. Y. Choueiri, J. Tylka, R. Sridhar, and B. Boren. Method and system for producing low-noise acoustical impulse responses at high sampling rate, May 1, 2018. US Patent 9,959,883.

⁷ J. G. Tylka, B. B. Boren, and E. Y. Choueiri. A Generalized Method for Fractional-Octave Smoothing of Transfer Functions that Preserves Log-Frequency Symmetry. *The Journal of the Audio Engineering Society*, 65(3):239–245, March 2017.